



# Solid State Devices, Inc.

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# SPMR600-01

## SPACE LEVEL SHUNT MODULE

**Designer's Data Sheet**

**Part Number/Ordering Information <sup>1/</sup>**

**SPMR600-01**

**Screening <sup>2/</sup>**

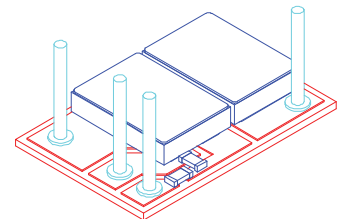
— = Not Screened  
 TX = TX Level  
 TXV = TXV  
 S = S Level

- FEATURES:**
- Space Level Power Supply Applications
  - Compact and Rugged Construction Offering Weight and Space Savings
  - Very Low Mechanical Stress and Thermal Resistance
  - Hermetic Sealed Discrete Elements
  - Excellent Thermal Management
  - TX, TXV, and Space Level Screening Available

150V Schottky section: Maximum Ratings	Symbol	Value	Units
Peak Surge Reverse Voltage	V <sub>RSM</sub>	150	V
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	150	V
Average Rectified Forward Current (Resistive Load, 60 Hz Sine Wave, T <sub>A</sub> = 25 °C)	I <sub>O</sub> I <sub>D2</sub>	40	A
Non-repetitive Peak Surge Current (8.3 ms Pulse, Half Sine Wave)	I <sub>FSM</sub>	600	A
Max. Avalanche repetitive reverse current	I <sub>AR</sub>	0.6	A
Non-repetitive Avalanche Energy	E <sub>AS</sub>	0.6	mJ
Total Power Dissipation	P <sub>d</sub>	TBD	W
Operating & Storage Temperature	T <sub>OP</sub> & T <sub>STG</sub>	-55 to+175	°C

150V Schottky section: Electrical Characteristics	Symbol	Min	Typ	Max	Units
Instantaneous Forward Voltage Drop (Pulsed, T <sub>A</sub> = 25 °C)	I <sub>F</sub> = 10A <sub>dc</sub> V <sub>F1</sub>	—	0.650	0.75	V
	I <sub>F</sub> = 20A <sub>dc</sub> V <sub>F2</sub>	—	0.715	0.80	
	I <sub>F</sub> = 40A <sub>dc</sub> V <sub>F3</sub>	—	0.775	0.85	
Instantaneous Forward Voltage Drop (Pulsed, T <sub>A</sub> = 125 °C)	I <sub>F</sub> = 10A <sub>dc</sub> V <sub>F4</sub>	—	0.500	0.64	V
	I <sub>F</sub> = 20A <sub>dc</sub> V <sub>F5</sub>	—	0.560	0.68	
	I <sub>F</sub> = 40A <sub>dc</sub> V <sub>F6</sub>	—	0.640	0.75	
Instantaneous Forward Voltage Drop (Pulsed, T <sub>A</sub> = -55 °C)	I <sub>F</sub> = 10A <sub>dc</sub> V <sub>F7</sub>	—	0.800	0.90	V
	I <sub>F</sub> = 20A <sub>dc</sub> V <sub>F8</sub>	—	0.840	0.96	
	I <sub>F</sub> = 40A <sub>dc</sub> V <sub>F9</sub>	—	0.925	1.03	
Reverse Leakage Current (Pulsed, T <sub>A</sub> = 25 °C)	V <sub>R</sub> = 150 V IR <sub>1</sub>	—	10	500	µA
Reverse Leakage Current (Pulsed, T <sub>A</sub> = 125 °C)	V <sub>R</sub> = 150 V IR <sub>2</sub>	—	5	50	mA
Reverse Leakage Current (Pulsed, T <sub>A</sub> = 150 °C)	V <sub>R</sub> = 150 V IR <sub>3</sub>	—	10	—	mA
Junction Capacitance (T <sub>A</sub> = 25°C, f = 1MHz)	V <sub>R</sub> = 10V C <sub>J</sub>	—	1000	1250	pF

**Notes:** 1/ For ordering information, price, and availability- Contact factory.  
 2/ Screening based on MIL-PRF-19500. Screening flows available on request.





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250V MOSFET section: Maximum Ratings		Symbol	Value	Units		
Drain - Source Voltage		$V_{DSS}$	250	V		
Gate - Source Voltage	continuous transient	$V_{GS}$	$\pm 20$ $\pm 30$	V		
Max. Continuous Drain Current (package limited)	@ $T_C = 25^\circ C$ @ $T_C = 125^\circ C$	$I_{D1}$ $I_{D2}$	85 70	A		
Pulsed Drain (Instantaneous) Current (Tj limited)	@ $T_C = 25^\circ C$	$I_{D3}$	110	A		
Max. Avalanche current	@ $L = 0.1$ mH	$I_{AR}$	25	A		
Single / Repetitive Avalanche Energy	@ $L = 0.1$ mH	$E_{AS}$	1000	mJ		
Total Power Dissipation	@ $T_C = 25^\circ C$	$P_D$	250	W		
Operating & Storage Temperature		$T_{OP}$ & $T_{STG}$	-55 to +150	$^\circ C$		
250V MOSFET section: Electrical Characteristics <sup>18</sup>		Symbol	Min	Typ	Max	Units
Drain to Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	250	—	—	V
Drain to Source On State Resistance	$V_{GS} = 10V, I_D = 55A, T_J = 25^\circ C$ $V_{GS} = 10V, I_D = 55A, T_J = 125^\circ C$	$R_{DS(on)}$	— —	24 45	28 —	m $\Omega$
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1$ mA, $T_J = 25^\circ C$ $V_{DS} = V_{GS}, I_D = 1$ mA, $T_J = -55^\circ C$ $V_{DS} = V_{GS}, I_D = 1$ mA, $T_J = 125^\circ C$	$V_{GS(th)}$	2.5 — —	3.0 4.2 1.5	4.5 — —	V
Gate to Source Leakage	$V_{GS} = \pm 20V, T_J = 25^\circ C$ $V_{GS} = \pm 20V, T_J = 125^\circ C$	$I_{GSS}$	— —	10 30	$\pm 200$ —	nA
Zero Gate Voltage Drain Current	$V_{DS} = 250V, V_{GS} = 0V, T_J = 25^\circ C$ $V_{DS} = 250V, V_{GS} = 0V, T_J = 125^\circ C$	$I_{DSS}$	— —	0.01 10	5 250	$\mu A$ $\mu A$
Forward Transconductance	$V_{DS} = 10V, I_D = 55A, T_J = 25^\circ C$	$g_{fs}$	50	100	—	Mho
Total Gate Charge	$V_{GS} = 10V$	$Q_g$	—	160	—	nC
Gate to Source Charge	$V_{DS} = 125V$	$Q_{gs}$	—	40	—	nC
Gate to Drain Charge	$I_D = 25A$	$Q_{gd}$	—	50	—	nC
Turn on Delay Time	$V_{GS} = 15V$	$t_{d(on)}$	—	20	—	nsec
Rise Time	$V_{DS} = 125V$	$t_r$	—	30	—	
Turn off Delay Time	$I_D = 55A$	$t_{d(off)}$	—	60	—	
Fall Time	$R_G = 2.0\Omega, pw = 3\mu s$	$t_f$	—	30	—	
Diode Forward Voltage	$I_F = 55A, V_{GS} = 0V$	$V_{SD}$	—	0.9	1.2	V
Diode Reverse Recovery Time		$t_{rr}$	—	175	—	nsec
Peak Reverse Recovery Current	$I_F = 55A, di/dt = 250A/\mu sec$	$I_{RM(rec)}$	—	27	—	A
Reverse Recovery Charge		$Q_{rr}$	—	2.5	—	$\mu C$
Input Capacitance	$V_{GS} = 0V$	$C_{iss}$	—	9400	—	pF
Output Capacitance	$V_{DS} = 25V$	$C_{oss}$	—	850	—	
Reverse Transfer Capacitance	$f = 1$ MHz	$C_{rss}$	—	60	—	

**NOTE:** All specifications are subject to change without notification.  
 SCD's for these devices should be reviewed by SSDI prior to release.

**DATA SHEET #: PM0025A**

**DOC**

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**CASE OUTLINE: ASPM**

